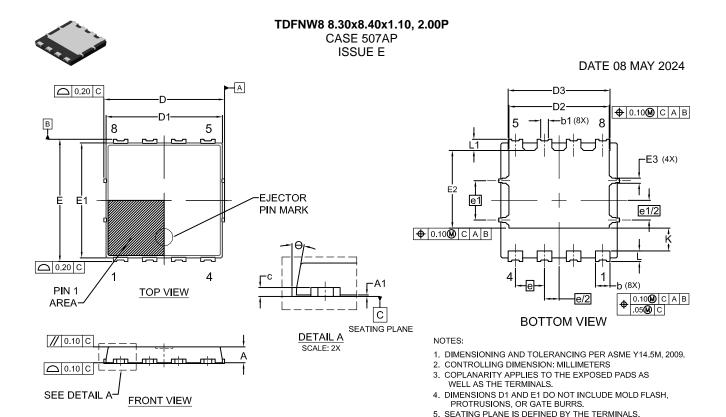
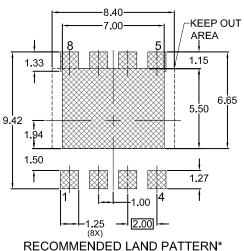
"A1" IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.

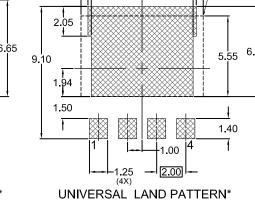
KEEP OUT

AREA









8.40

7.45

7.00

DIM	MILLIMETERS			
Di.v.	MIN.	NOM.	MAX.	
Α	1.00	1.10	1.20	
A1	0.00	-	0.05	
b	0.90	1.00	1.10	
b1	0.35	0.45	0.55	
O	0.23	0.28	0.33	
О	8.20	8.30	8.40	
D1	7.90	8.00	8.10	
D2	6.80	6.90	7.00	
D3	6.90	7.00	7.10	
Е	8.30	8.40	8.50	
E1	7.80	7.90	8.00	
E2	5.24	5.34	5.44	
E3	0.25	0.35	0.45	
е	2.00 BSC			
e/2	1.00 BSC			
e1	2.70 BSC			
e1/2	1.35 BSC			
K	1.50	1.57	1.70	
٦	0.64	0.74	0.84	
L1	0.67	0.77	0.87	
θ	0°		12°	

*FOR ADDITIONAL INFORMATION ON OUR PB-FREE
STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD
THE ONSEMI SOLDERING AND MOUNTING TECHNIQUES
REFERENCE MANUAL, SOLDERRM/D.

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DESCRIPTION:

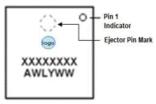
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CASE 507AP ISSUE E

DATE 08 MAY 2024

GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code
A = Assembly Location
WL = Wafer Lot Code
Y = Year Code
WW = Work Week Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot " •", may or may not be present. Some products may not follow the Generic Marking.

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